Special Issue

Al in Software Engineering: Challenges, Solutions and Applications

Message from the Guest Editors

Researchers and practitioners are invited to submit original studies for the Special Issue on "AI in Software Engineering: Challenges, Solutions and Applications", which aims to explore the transformative role of artificial intelligence in software engineering, addressing both current challenges and pioneering solutions. We welcome submissions covering Al-driven approaches to software engineering, design, testing, maintenance, and project management. Topics may also include innovative AI applications for code generation, debugging, quality assurance, and enhancing developer productivity. This Special Issue offers a platform for multidisciplinary insights that bridge Al advancements and software engineering needs. Join us in advancing knowledge on Al's potential to shape the future of software engineering. We look forward to receiving your contributions.

Guest Editors

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Deadline for manuscript submissions

closed (20 June 2025)



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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

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